

MXG02 Facts and Data



Digital Monochrome Board Level Camera, VGA, Gigabit Ethernet

Sensor Information

Model Name	SONY® ICX618
Туре	1/4" progressive scan CCD, EXview HAD technology
Native Resolution	656 × 490 pixels
Exposure Time	4 μsec 60 sec

Acquisition Formats

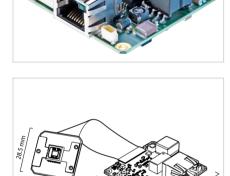
Image Formats	Full Frame	656 × 490 pixels	max.	160.0 fps
Pixel Formats	Mono8, Mono12, Mono	12 Packed		
Partial Scan	True Partial Scan, Region	of Interest (ROI) arbitrary		

Image Pre-processing

Analog Controls	Gain (0 26 dB), Offset (0 1023 LSB 14 bit)
Color Models	Mono

Camera Features

Internal Buffer	120 MB (max. 30 images)
Synchronization	Free running, Trigger
Trigger Sources	Hardware, Software, ActionCommand, All or Off
Trigger Delay	0 2 sec, Tracking and buffering of up to 512 triggers
Sequencer	Automated control for series of images using different sets of parameters
Sequencer Characteristics	up to 128 sets of parameters, up to 65536 loop passes, up to 65536 repeti- tions of sets of parameters, up to 65536 images per trigger event
Sequencer Parameters	Exposure Time, Gain Factor, Output Line, ROI Offset x, ROI Offset y
Digital I/Os	1 input line, 3 output lines



Interfaces and Connectors

Data Interface	Gigabit Ethernet, Transfer rate 1000 Mbits/sec Fast Ethernet, Transfer Rate 100 Mbits/sec Connector: 8P8C Modular Jack (RJ45)
Process Interface	JSTBM08B-SRSS-TB 8 pins
Power Interface	JSTBM03B-SRSS-TB 3 pins



Mechanical Data

Housing	Board Level Camera without housing
Lens Mount	C-Mount (Adapter)
Dimensions	Sensorprint 28,5 x 28,5 Systemprint 48,0 x 48,0
Weight	30 g (without Optics Adapter)



Electrical Data

Licetifical Data	
Power Supply	12 24 V DC (external Power Supply) 36 57 V DC (Power over Ethernet)
Power Consumption	approx. 3.4 Watts @ 12 V DC and 160.0 fps approx. 3.7 Watts @ 48 V DC (PoE) and 160.0 fps

Baumer Optronic GmbH Badstrasse 30 DE-01454 Radeberg, Germany Phone +49 (0)3528 4386 0 Fax +49 (0)3528 4386 86 sales@baumeroptronic.com www.baumer.com/cameras

Environmental Data

LiiviioiiiiCiitai Data	
Storage Temperature	-10 °C +70 °C
Operating Temperature	Depends on the thermal encapsulation
Device Temperature	T _{max} = 70 °C @ Measurement Point
Humidity	10% 90% non condensing